

Silicon diffused power transistor

BU2522AF

GENERAL DESCRIPTION

New generation, high-voltage, high-speed switching npn transistor in a plastic full-pack envelope intended for use in horizontal deflection circuits of high resolution monitors. Features improved RBSOA performance and is suitable for operation up to 64 kHz.

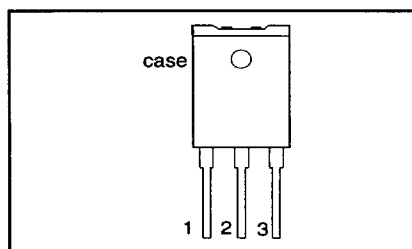
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V_{CESM}	Collector-emitter voltage peak value	$V_{BE} = 0\text{ V}$	-	1500	V
V_{CEO}	Collector-emitter voltage (open base)		-	800	V
I_C	Collector current (DC)		-	10	A
I_{CM}	Collector current peak value		-	25	A
P_{tot}	Total power dissipation	$T_{hs} \leq 25\text{ °C}$	-	45	W
V_{CESat}	Collector-emitter saturation voltage	$I_C = 6.0\text{ A}; I_B = 1.76\text{ A}$	-	5.0	V
I_{Csat}	Collector saturation current		6.0	-	A
t_s	Storage time	$I_{CM} = 6.0\text{ A}; I_{B(on)} = 0.7\text{ A}$	1.7	2.0	μs

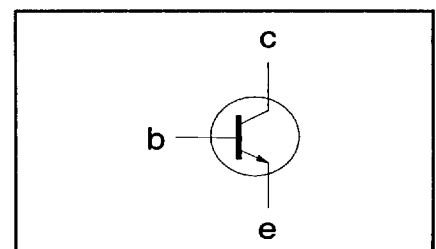
PINNING - SOT199

PIN	DESCRIPTION
1	base
2	collector
3	emitter
case	isolated

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CESM}	Collector-emitter voltage peak value	$V_{BE} = 0\text{ V}$	-	1500	V
V_{CEO}	Collector-emitter voltage (open base)		-	800	V
I_C	Collector current (DC)		-	10	A
I_{CM}	Collector current peak value		-	25	A
I_B	Base current (DC)		-	6	A
I_{BM}	Base current peak value		-	9	A
$-I_{B(AV)}$	Reverse base current	average over any 20 ms period	-	150	mA
$-I_{BM}$	Reverse base current peak value ¹		-	6	A
P_{tot}	Total power dissipation	$T_{hs} \leq 25\text{ °C}$	-	45	W
T_{stg}	Storage temperature		-65	150	°C
T_j	Junction temperature		-	150	°C

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th\ j-hs}$	Junction to heatsink	without heatsink compound	-	3.7	K/W
$R_{th\ j-hs}$	Junction to heatsink	with heatsink compound	-	2.8	K/W
$R_{th\ j-a}$	Junction to ambient	in free air	35	-	K/W

¹ Turn-off current.

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ISOLATION

 $T_{hs} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{isol}	Repetitive peak voltage from all three terminals to external heatsink	R.H. $\leq 65\%$; clean and dustfree	-	-	2500	V
C_{isol}	Capacitance from T2 to external heatsink	$f = 1\text{ MHz}$	-	22	-	pF

STATIC CHARACTERISTICS

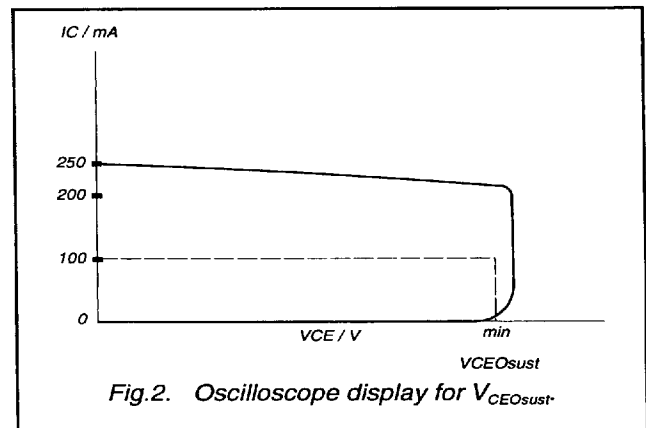
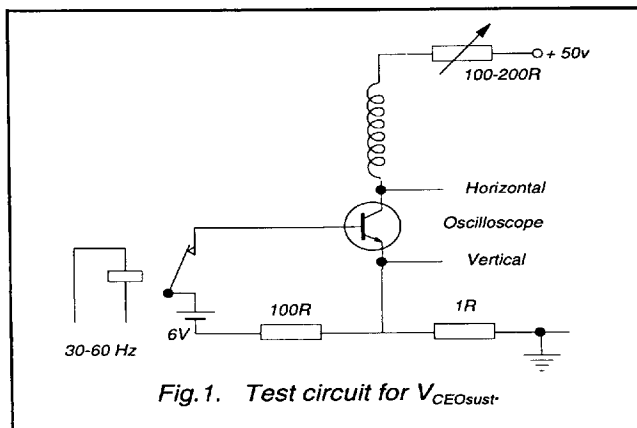
 $T_{hs} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CES}	Collector cut-off current ²	$V_{BE} = 0\text{ V}; V_{CE} = V_{CESMmax}$	-	-	0.25	mA
I_{CES}		$V_{BE} = 0\text{ V}; V_{CE} = V_{CESMmax}; T_J = 125\text{ }^{\circ}\text{C}$	-	-	2.0	mA
I_{EBO}	Emitter cut-off current	$V_{EB} = 7.5\text{ V}; I_C = 0\text{ A}$	-	-	0.25	mA
$V_{CEOsust}$	Collector-emitter sustaining voltage	$I_B = 0\text{ A}; I_C = 100\text{ mA}; L = 25\text{ mH}$	800	-	-	V
V_{CEsat}	Collector-emitter saturation voltage	$I_C = 6.0\text{ A}; I_B = 1.76\text{ A}$	-	-	5.0	V
V_{BEsat}	Base-emitter saturation voltage	$I_C = 6.0\text{ A}; I_B = 1.76\text{ A}$	-	-	1.3	V
h_{FE}	DC current gain	$I_C = 1\text{ A}; V_{CE} = 5\text{ V}$	8	10	21	
h_{FE}		$I_C = 6\text{ A}; V_{CE} = 5\text{ V}$	5	7	8	

DYNAMIC CHARACTERISTICS

 $T_{hs} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

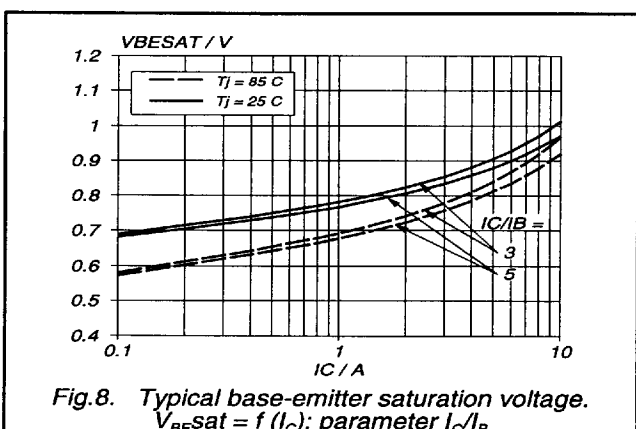
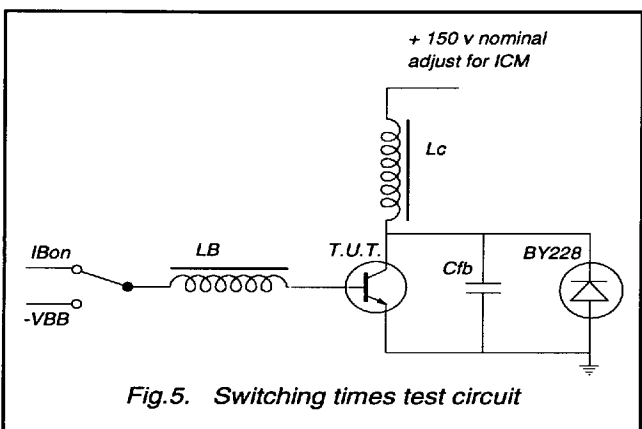
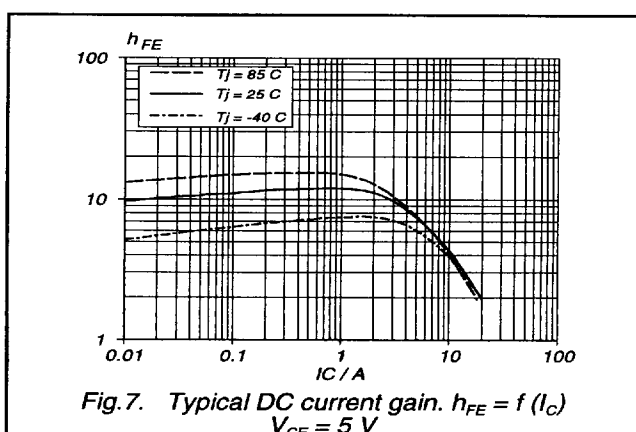
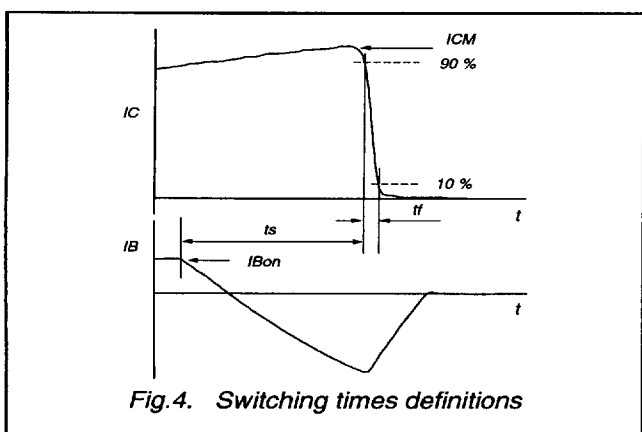
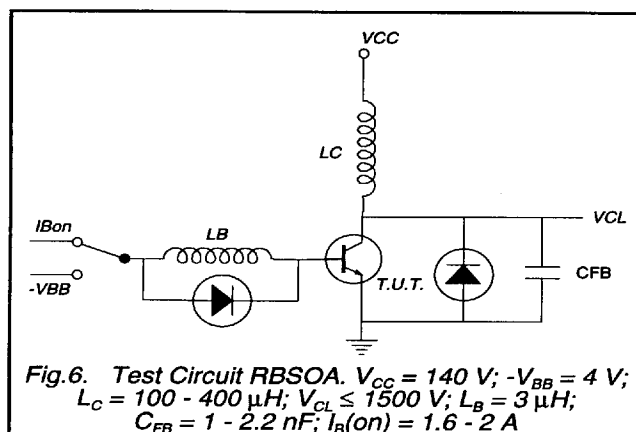
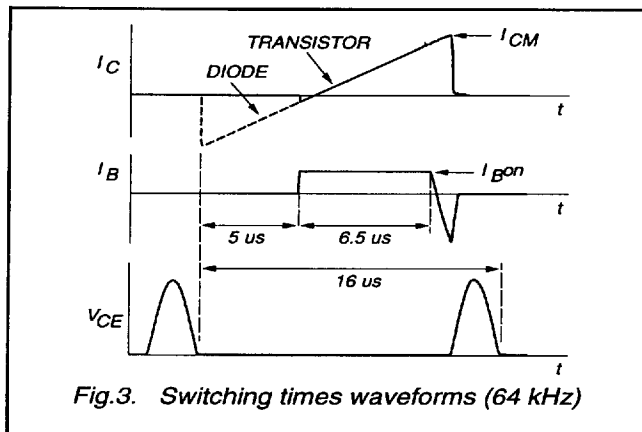
SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
C_c	Collector capacitance	$I_E = 0\text{ A}; V_{CB} = 10\text{ V}; f = 1\text{ MHz}$	115	-	pF
	Switching times (64 kHz line deflection circuit)	$I_{CM} = 6.0\text{ A}; L_C = 170\text{ }\mu\text{H}; C_{fb} = 5.4\text{ nF}; I_{B(end)} = 0.7\text{ A}; L_B = 0.6\text{ }\mu\text{H}; -V_{BB} = 2\text{ V}; (-di_B/dt = 3.33\text{ A}/\mu\text{s})$			
t_s	Turn-off storage time		1.7	2.0	μs
t_f	Turn-off fall time		0.12	0.25	μs



2 Measured with half sine-wave voltage (curve tracer).

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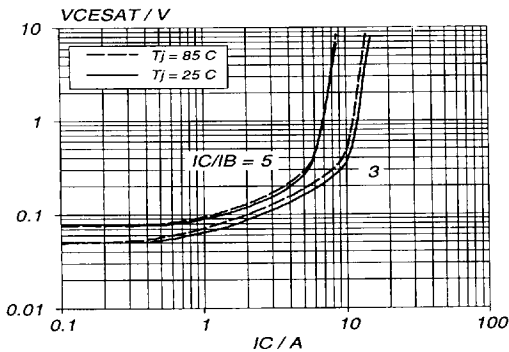


Fig. 9. Typical collector-emitter saturation voltage.
 $V_{CEsat} = f(I_C)$; parameter I_C/I_B

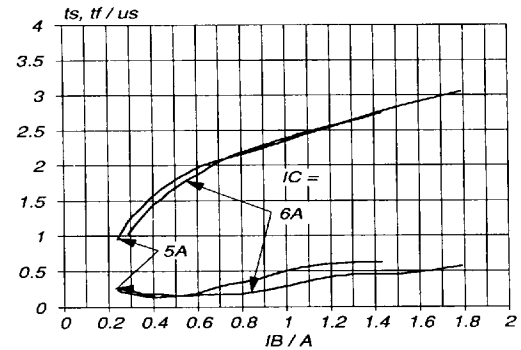


Fig. 12. Typical collector storage and fall time.
 $t_s = f(I_B)$; $t_f = f(I_B)$; parameter I_C ; $T_j = 85^\circ\text{C}$; $f = 64\text{ kHz}$

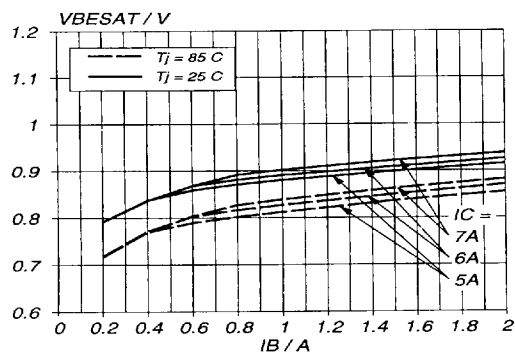


Fig. 10. Typical base-emitter saturation voltage.
 $V_{BEsat} = f(I_B)$; parameter I_C

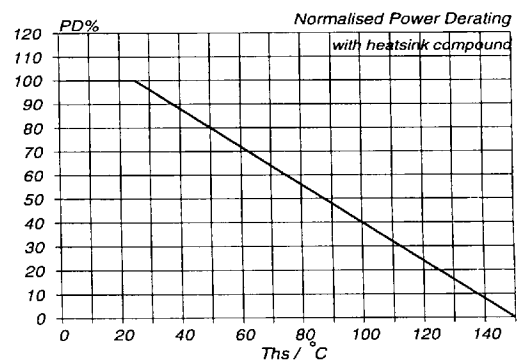


Fig. 13. Normalised power dissipation.
 $PD\% = 100 \cdot P_D/P_{D25^\circ\text{C}} = f(T_{hs})$

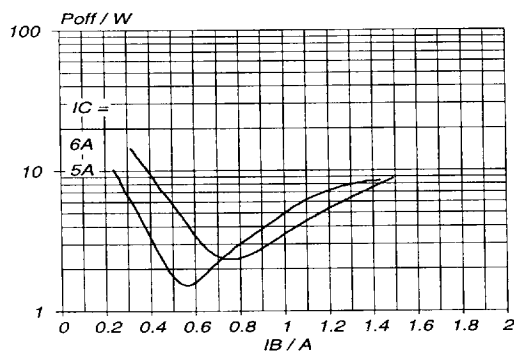


Fig. 11. Typical turn-off losses. $T_j = 85^\circ\text{C}$
 $P_{off} = f(I_B)$; parameter I_C ; $f = 64\text{ kHz}$

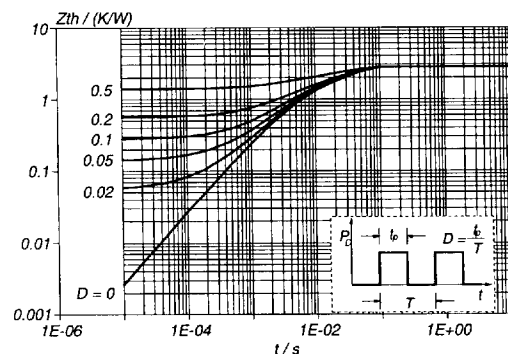


Fig. 14. Transient thermal impedance.
 $Z_{th\text{-}hs} = f(t)$; parameter $D = t_p/T$

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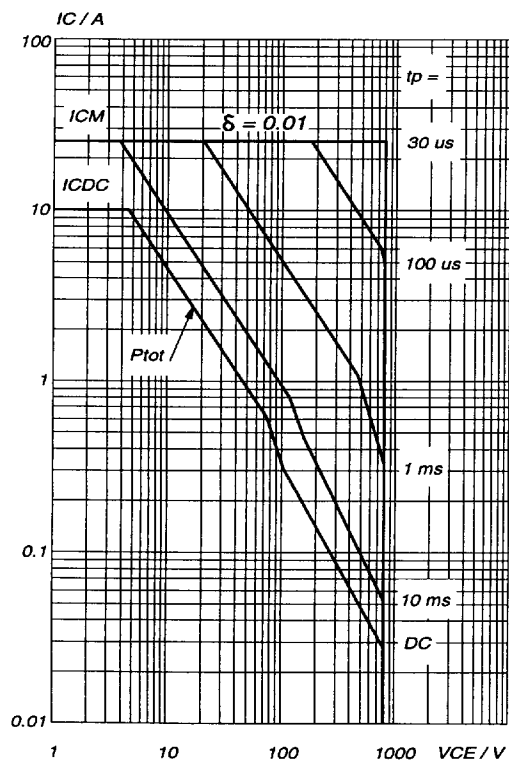


Fig. 15. Forward bias safe operating area. $T_{hs} = 25^\circ\text{C}$
 I_{CD} & $I_{CM} = f(V_{CE})$; I_{CM} single pulse; parameter t_p
 Second-breakdown limits independent of temperature.
 Mounted with heatsink compound.

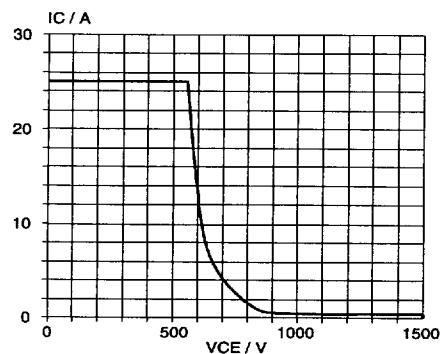


Fig. 16. Reverse bias safe operating area. $T_j \leq T_{jmax}$

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MECHANICAL DATA

Dimensions in mm

Net Mass: 5.5 g

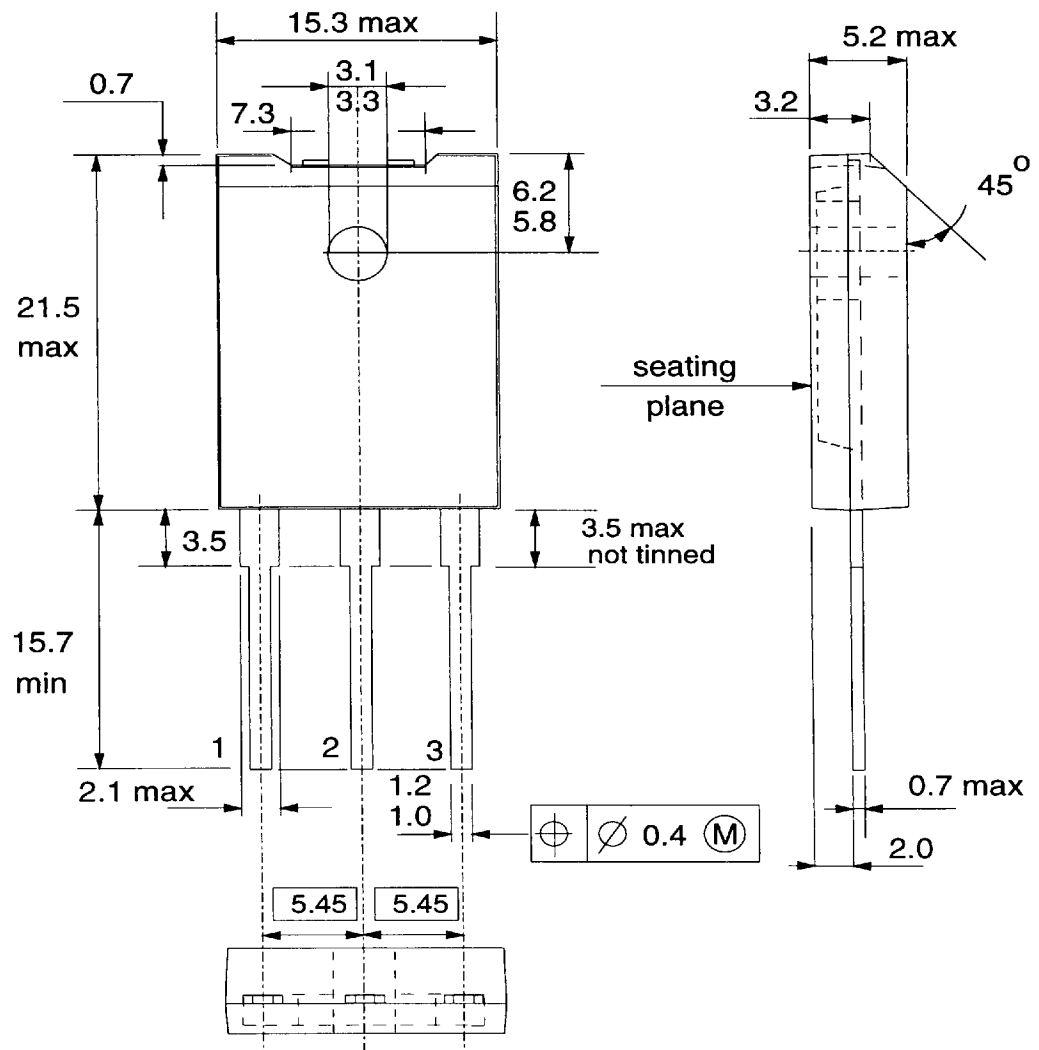


Fig.17. SOT199; The seating plane is electrically isolated from all terminals.

Notes

1. Accessories supplied on request: refer to mounting instructions for F-pack envelopes.

Silicon diffused power transistor**BU2522AF****DEFINITIONS**

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

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